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Dated: April 4, 2005

Signature: _____

(Michael R. Hill)

Docket No.: 30205/39512
(PATENT)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of:
Sung Koo Lee et al.

Application No.: 10/719,355

Confirmation No.: 3322

Filed: November 21, 2003

Art Unit: 1752

For: PHOTORESIST POLYMER AND
PHOTORESIST COMPOSITION INCLUDING
THE SAME

Examiner: Sin J. Lee

AMENDMENT AFTER ALLOWANCE UNDER 37 C.F.R. §1.312

MS Issue Fee
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

INTRODUCTORY COMMENTS

Please amend the above-noted application as follows.

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper.

Remarks/Arguments begin on page 9 of this paper.

Please
Enter
S.J.L.
5/2/2006